

## DC Input, High Voltage Photo Darlington Transistor Coupler

### Description

The SLM352 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar high voltage darlington phototransistor detector in a plastic SOP4 package.

With the robust coplanar double mold structure, SLM352 series provide the most stable isolation feature.

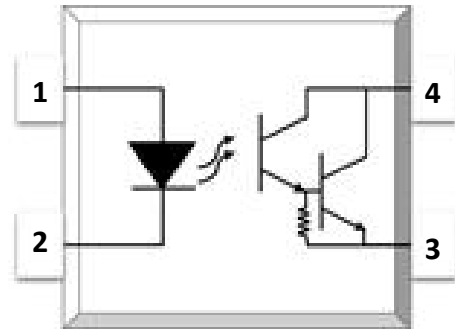
### Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range - 55 °C to 100 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
  - UL - UL1577
  - VDE - EN60747-5-5(VDE0884-5)
  - CQC - GB4943.1, GB8898
  - cUL- CSA Component Acceptance Service Notice No. 5A

### Applications

- Sequence controller
- Telephone/FAX
- System appliances, measuring instrument
- Programmable logic controller

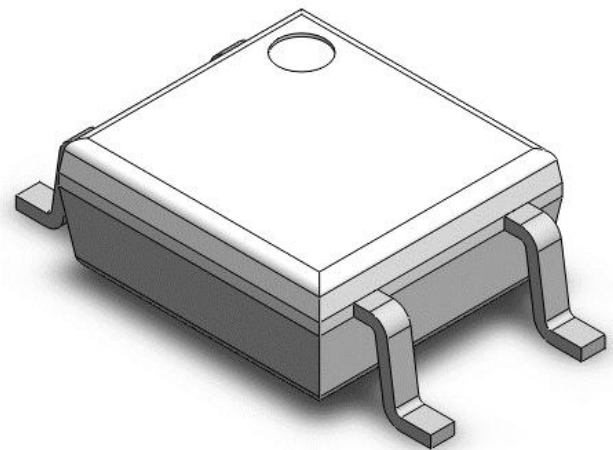
### SCHEMATIC



### PIN DEFINITION

1. Anode
2. Cathode
3. Emitter
4. Collector

### PACKAGE OUTLINE



**ABSOLUTE MAXIMUM RATINGS**

PARAMETER	SYMBOL	VALUE	UNIT	NOTE
<b>INPUT</b>				
Forward Current	$I_F$	60	mA	
Peak Forward Current	$I_{FP}$	1	A	1
Reverse Voltage	$V_R$	6	V	
Input Power Dissipation	$P_I$	100	mW	
<b>OUTPUT</b>				
Collector - Emitter Voltage	$V_{CEO}$	350	V	
Emitter - Collector Voltage	$V_{ECO}$	0.1	V	
Collector Current	$I_C$	150	mA	
Output Power Dissipation	$P_O$	150	mW	
<b>COMMON</b>				
Total Power Dissipation	$P_{tot}$	200	mW	
Isolation Voltage	$V_{iso}$	3750	V <sub>rms</sub>	2
Operating Temperature	$T_{opr}$	-55~110	°C	
Storage Temperature	$T_{stg}$	-55~125	°C	
Soldering Temperature	$T_{sol}$	260	°C	

Note 1. 100 $\mu$ s pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = 40 ~ 60%

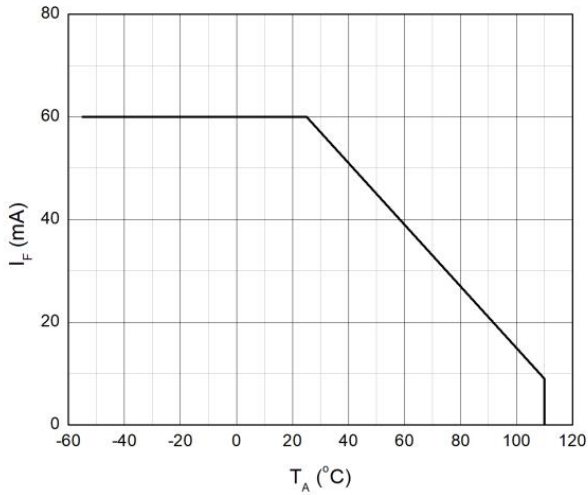
ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C							
PARAMETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT							
Forward Voltage	V <sub>F</sub>	-	1.24	1.4	V	IF=10mA	
Reverse Current	I <sub>R</sub>	-	-	10	μA	VR=6V	
Input Capacitance	C <sub>in</sub>	-	10	-	pF	V=0, f=1kHz	
OUTPUT							
Collector Dark Current	I <sub>CEO</sub>	-	-	200	nA	VCE=200V, IF=0	
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	350	-	-	V	IC=0.1mA, IF=0	
Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	0.1	-	-	V	IE=0.1mA, IF=0	
TRANSFER CHARACTERISTICS							
Current Transfer Ratio	CTR	1000	-	15000	%	IF=1mA, VCE=2V	
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	-	1.2	V	IF=20mA, IC=100mA	
Isolation Resistance	R <sub>ISO</sub>	10 <sup>12</sup>	10 <sup>14</sup>	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C <sub>IO</sub>	-	0.6	1	pF	V=0, f=1MHz	
Cut-off Frequency	f <sub>c</sub>	-	6	-	kHz	VCE=2V, IC=2mA RL=100Ω, -3dB	3
Response Time (Rise)	t <sub>r</sub>	-	91.5	300	μs	VCE=2V, IC=20mA RL=100Ω	4
Response Time (Fall)	t <sub>f</sub>	-	21.4	100	μs		4

Note 3. Fig.12&13

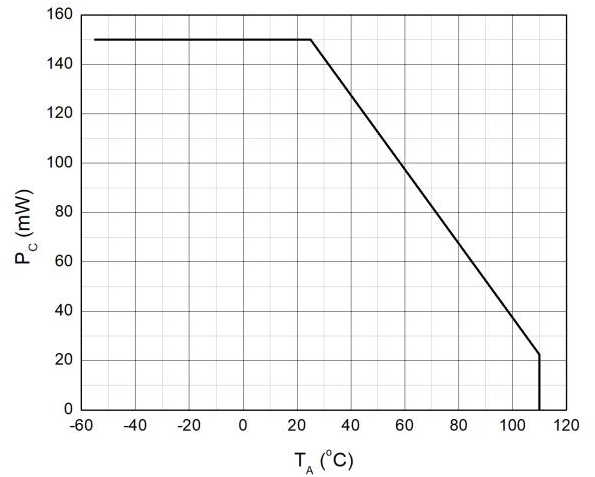
Note 4. Fig.14

## CHARACTERISTIC CURVES

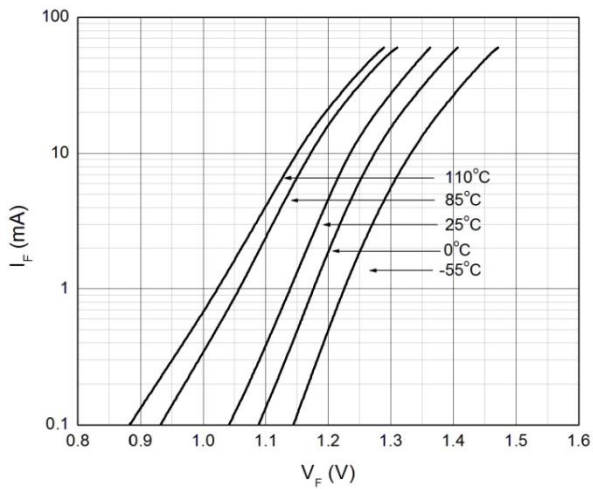
**Fig.1 Forward Current vs. Ambient Temperature**



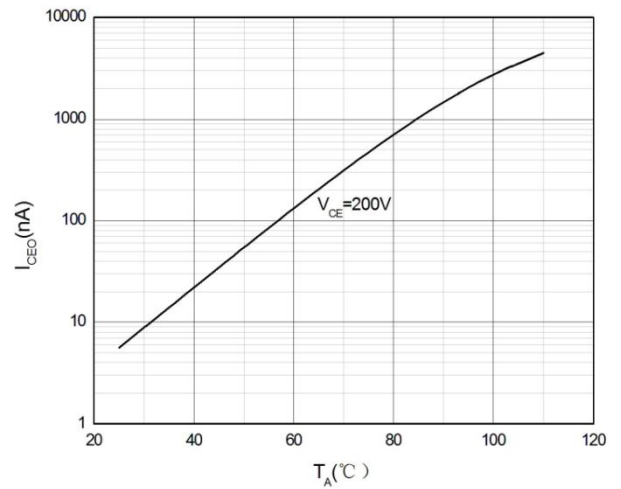
**Fig.2 Collector Power Dissipation vs. Ambient Temperature**



**Fig.3 Forward Current vs. Forward Voltage**

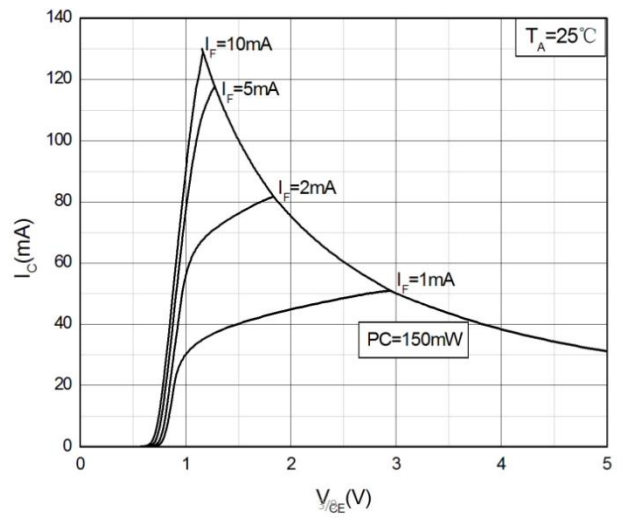
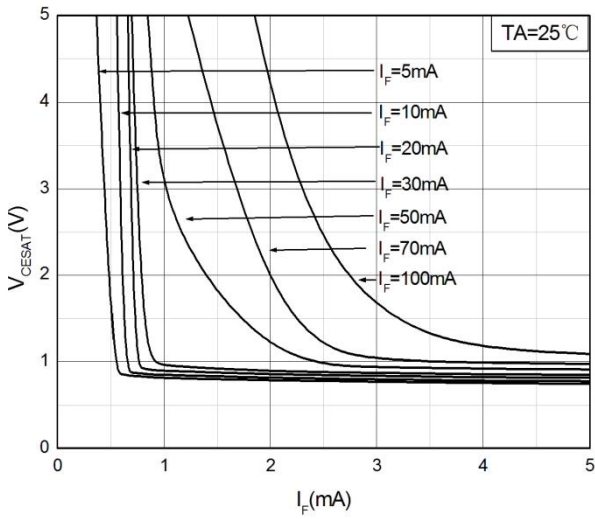


**Fig.4 Collector Dark Current vs. Ambient Temperature**



**Fig.5 Collector-emitter Saturation Voltage vs. Forward Current**

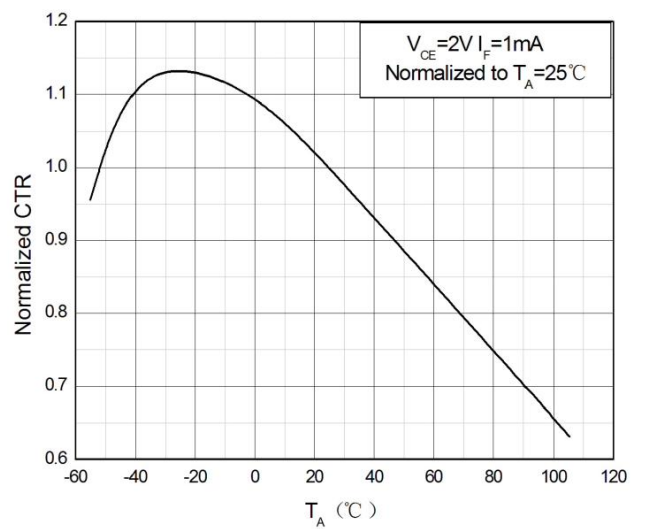
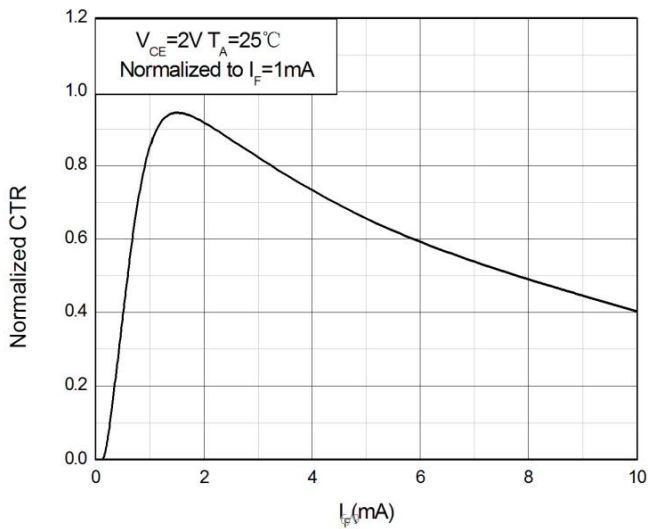
**Fig.6 Collector Current vs. Collector-emitter Voltage**



## CHARACTERISTIC CURVES

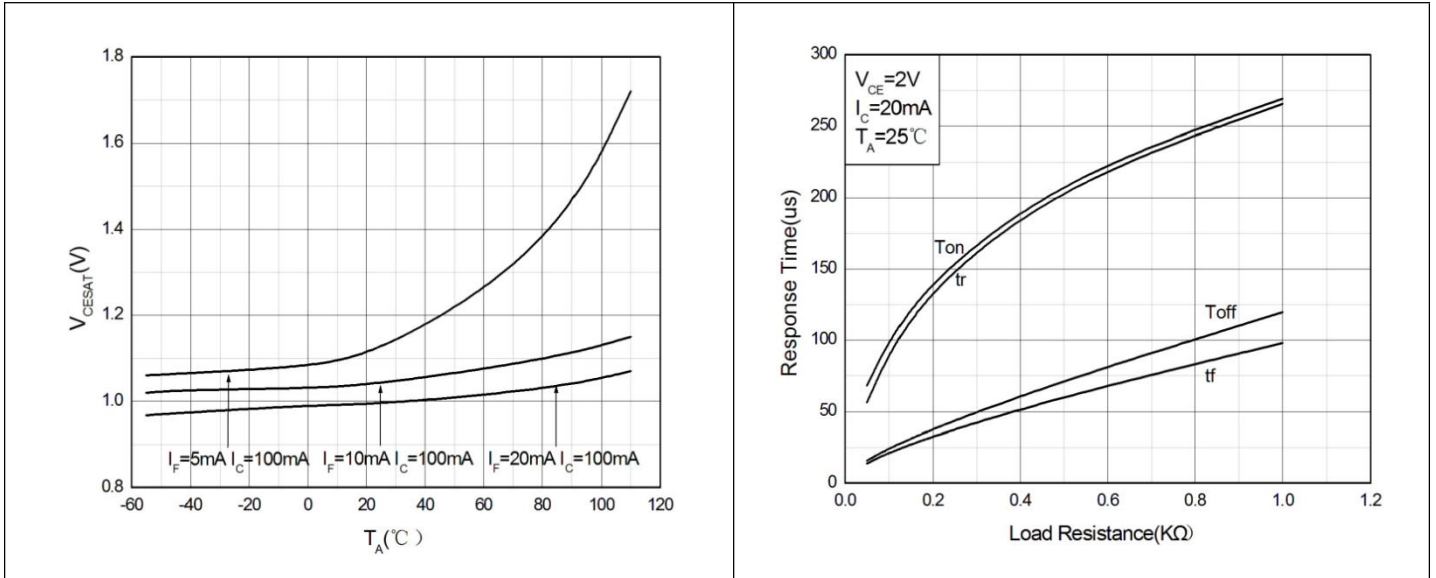
**Fig.7 Normalized Current Transfer Ratio vs. Forward Current**

**Fig.8 Normalized Current Transfer Ratio vs. Ambient Temperature**

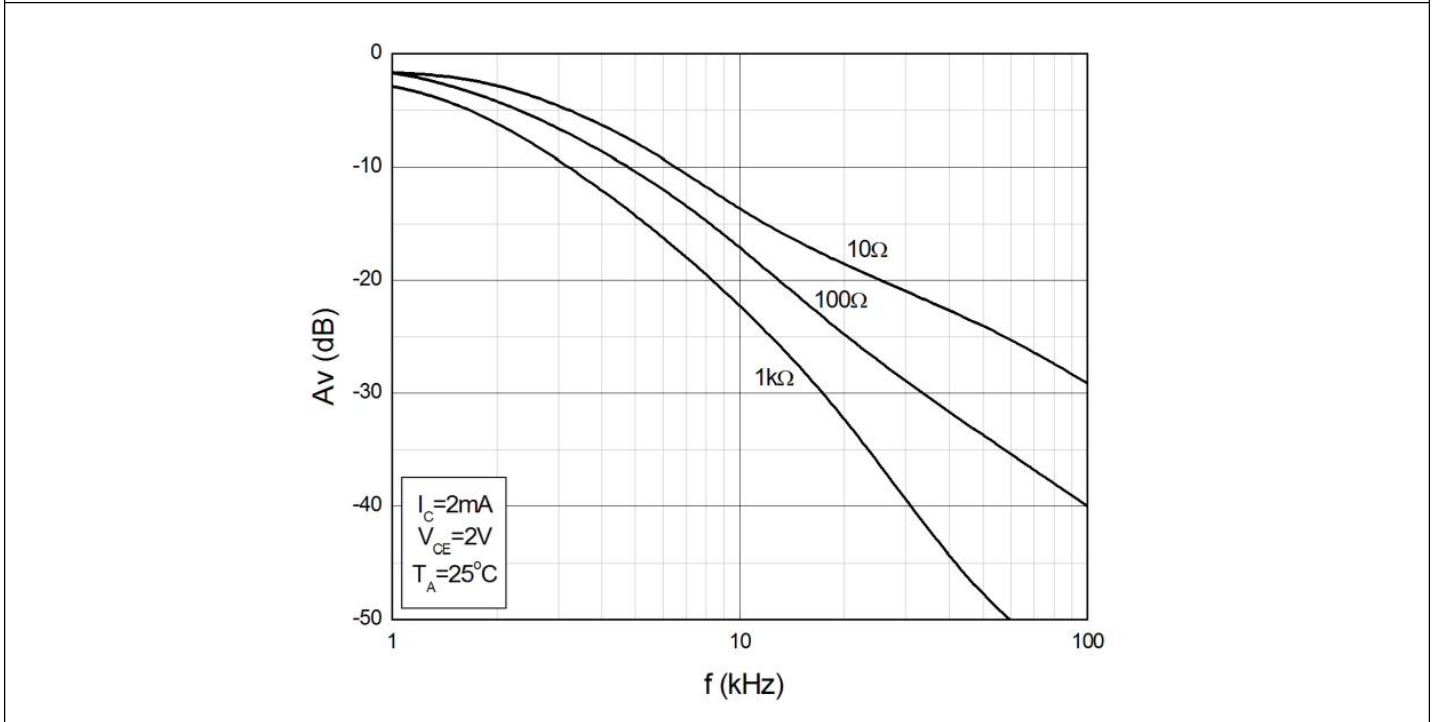


**Fig.9 Collector-emitter Saturation Voltage vs. Ambient Temperature**

**Fig.10 Switching Time vs. Load Resistance**



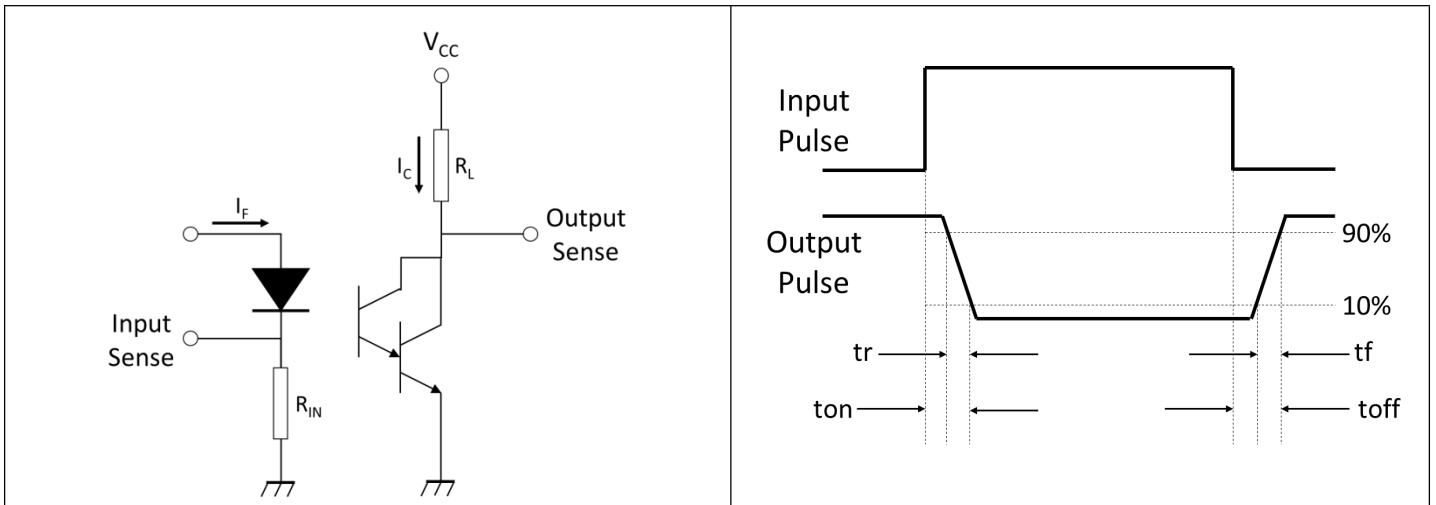
**Fig.11 Frequency Response**



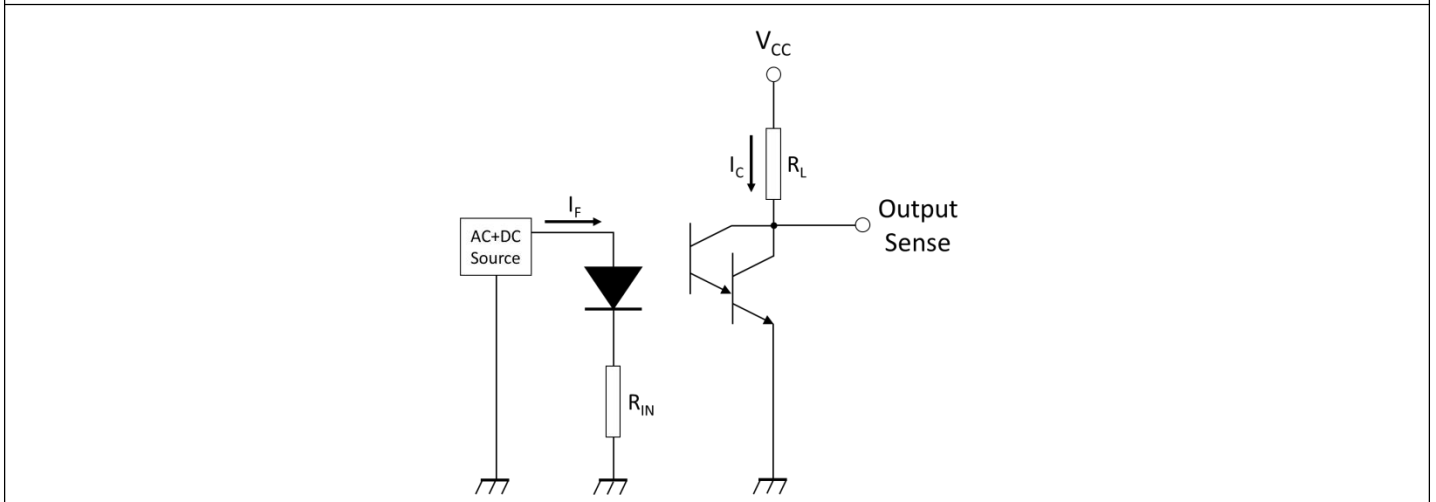
## TEST CIRCUITS

**Fig.12 Test Circuits of Response Time**

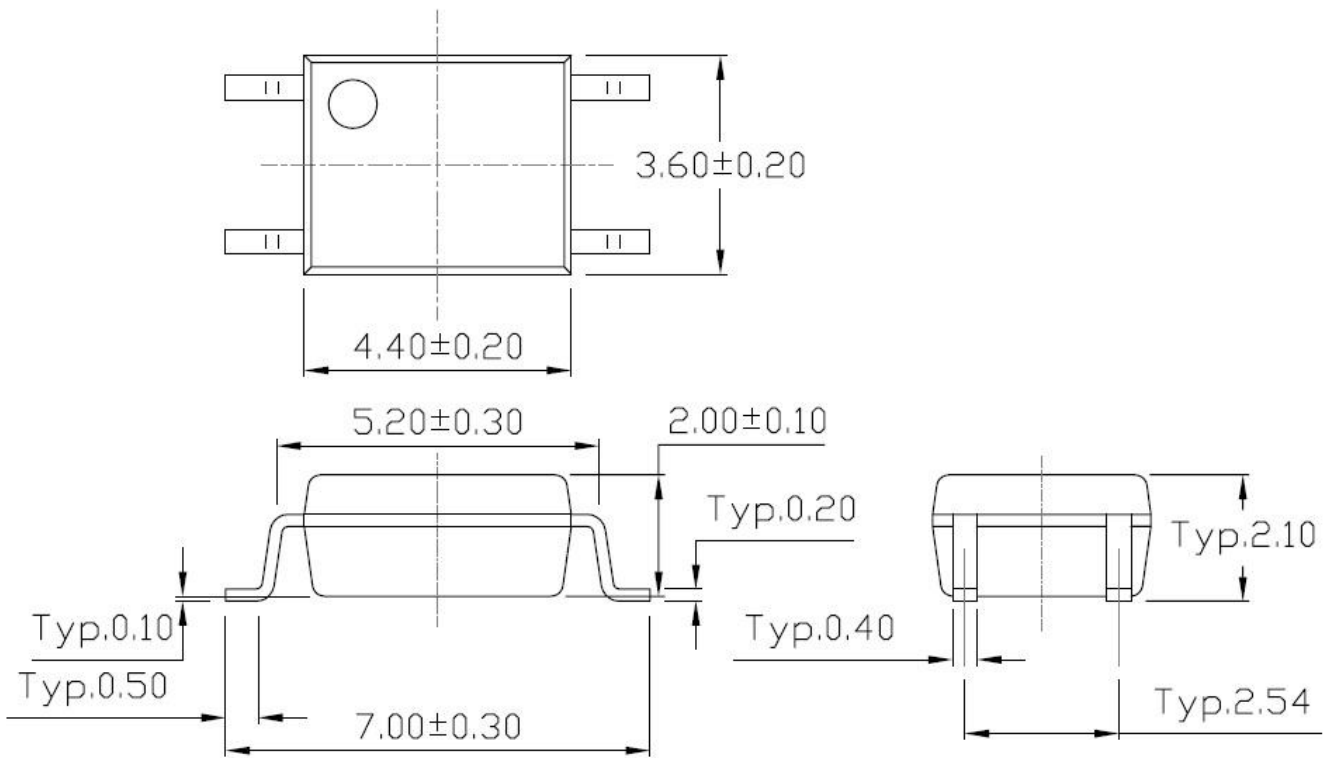
**Fig.13 Curves of Response Time**



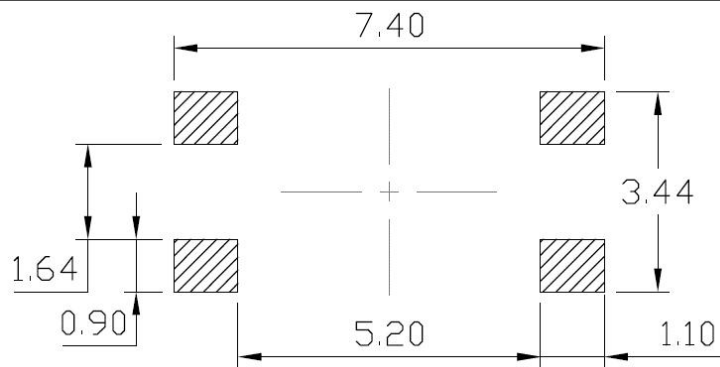
**Fig.14 Test Circuits of Frequency Response**



## PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)



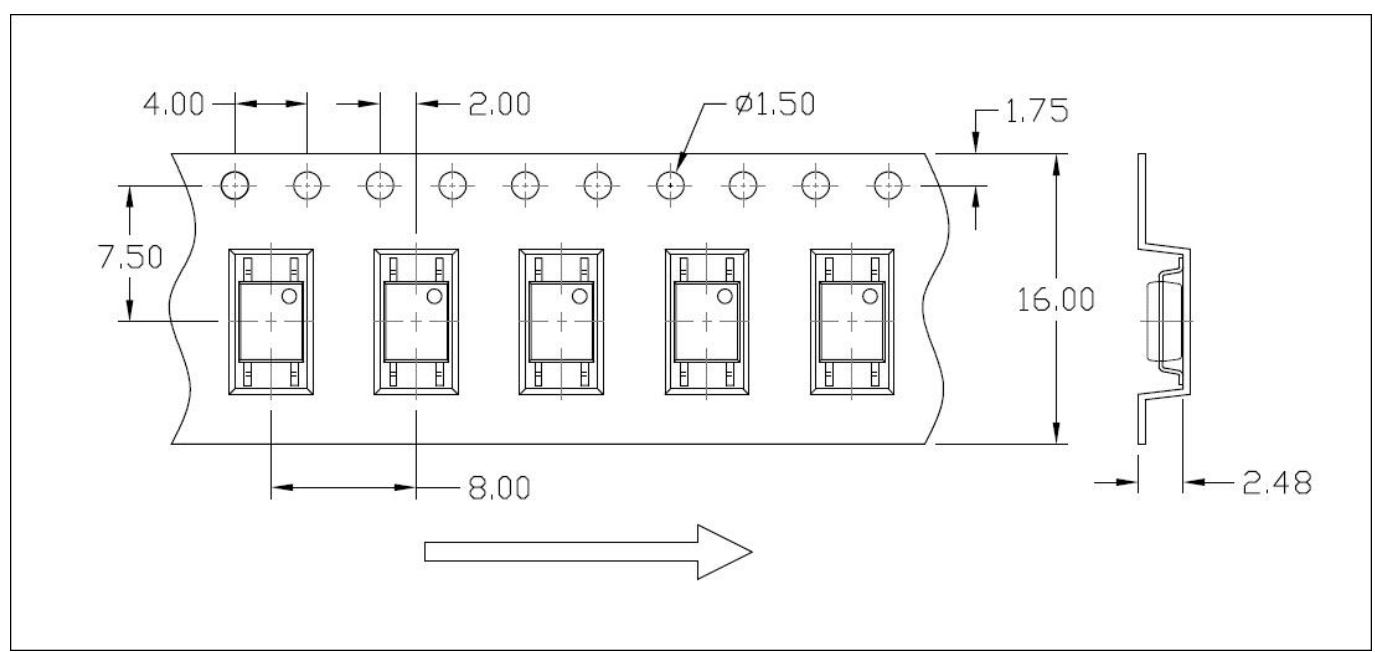
## Recommended Solder Mask (Dimensions in mm unless otherwise stated)



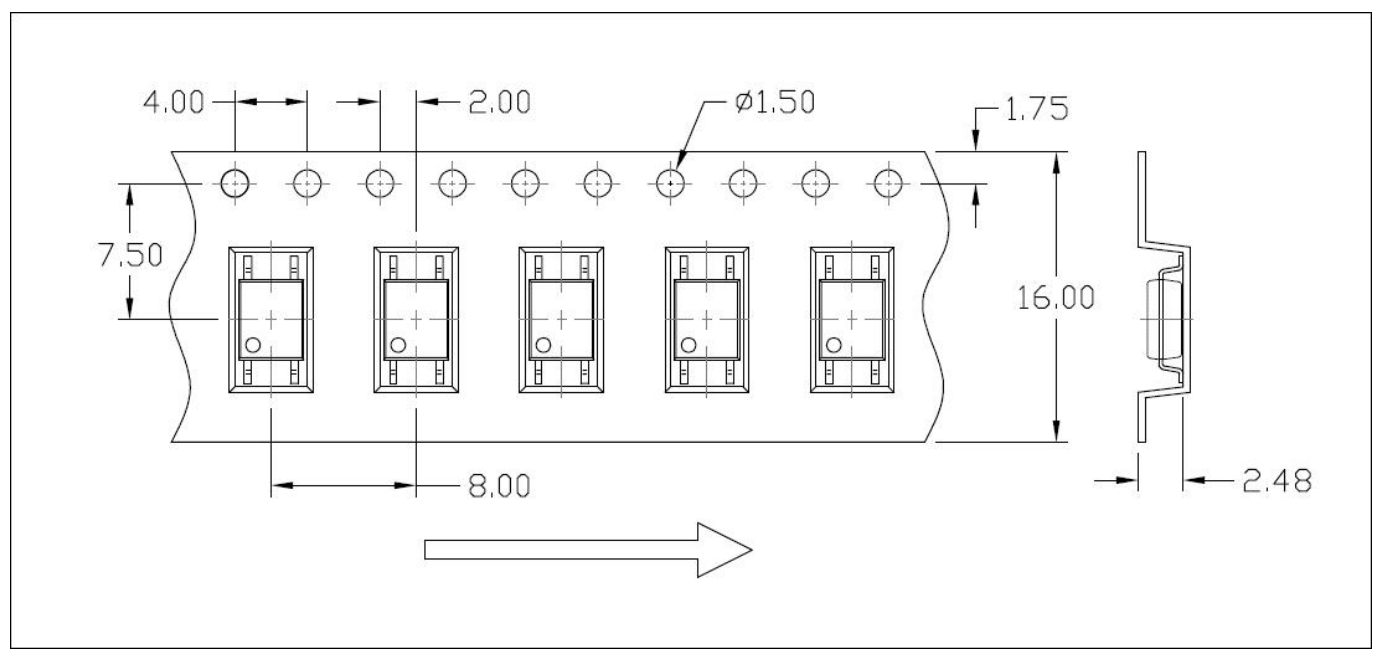


## CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

### Option T1

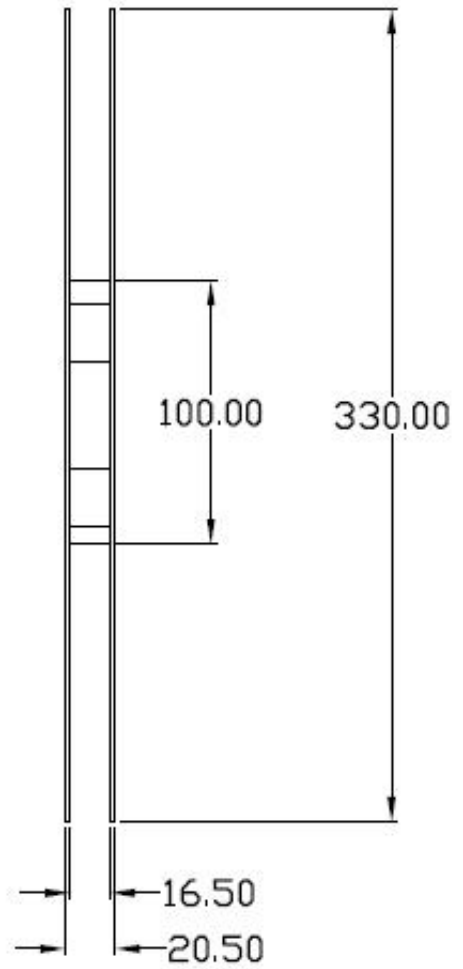
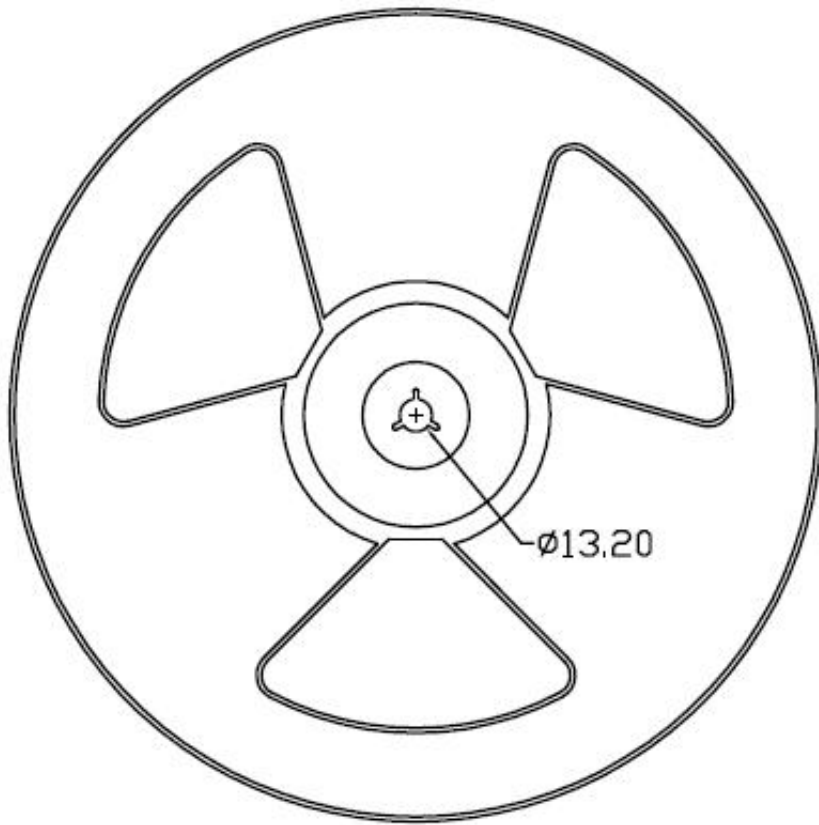


### Option T2



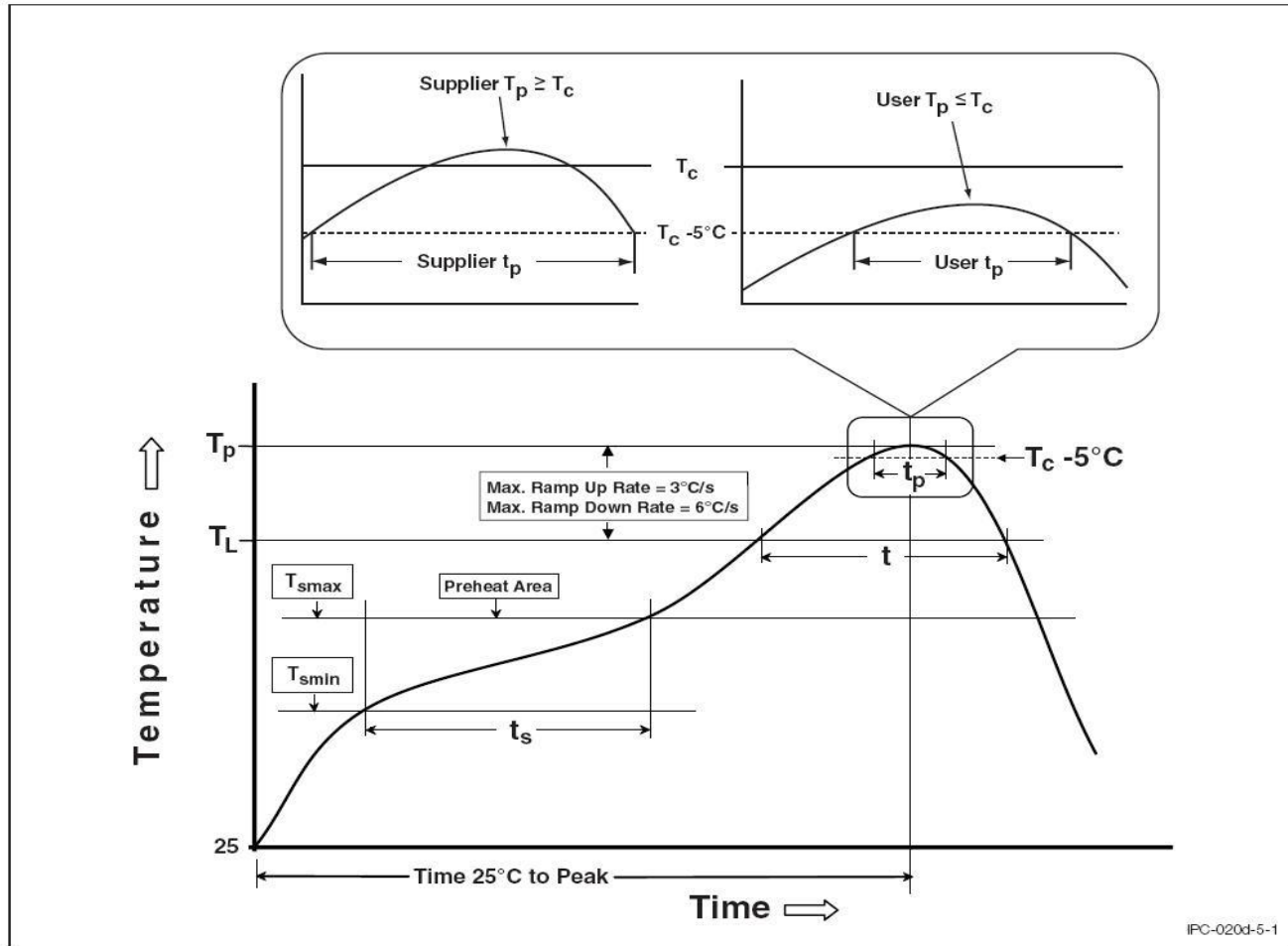
## REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated)

### Option T1 & T2



## REFLOW INFORMATION

### REFLOW PROFILE



IPC-020d-5-1

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. ( $T_{smin}$ )	100	150°C
Temperature Max. ( $T_{smax}$ )	150	200°C
Time ( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )	60-120 seconds	60-120 seconds
Ramp-up Rate ( $t_L$ to $t_P$ )	3°C/second max.	3°C/second max.
Liquidous Temperature ( $T_L$ )	183°C	217°C
Time ( $t_L$ ) Maintained Above ( $T_L$ )	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time ( $t_P$ ) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate ( $T_P$ to $T_L$ )	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.